

Digi-Key Electronics

PC#19MG04

Issued on: August 1, 2019 Asahi Kasei Microdevices Corporation

Product Change Notice

Regarding the following items shown below, we assemble wafer purchased from Omron Corporation. We were notified that Omron Corporation would change its test process of the wafer to the contracted test site to continue conducting the stable supply.

We would appreciate your understanding and acceptance the following change the schedule.

If you have any questions, please inquire to our distributors or our sales reps.

[Items]

EWxxx (excluding EW450, EW550, EW6672), EZ4xx, CQ1xx and EQ711L

[Summary of Change]

ICs we purchase from Omron will be test at the following site.

		Current	New	Change
	Wafer process	NJR Fukuoka Co., Ltd.%	NJR Fukuoka Corp. ※	No
	Wafer test	Omron Corp.	Saga Electronics Co., Ltd. ※	Yes
Vendor		Omron Corp.	Omron Corp.	No
Assembly		Asahi Kasei Microdevices	Asahi Kasei Microdevices	No
Final test		Corp.	Corp.	
Production		Production ends on Dec.,	Production starts on Jan.,	
Schedule		2019	2020	

※NJRC Group

[Schedule]

ICs will change from the lot produced after January, 2020. First delivery timing depends on the stock situation of the current items.

[Change Procedure]

Wafer itself does not change, as the change is only test site.

The stock will be controlled by the production lot, and the change will be executed in the order of the consumption of the stock of each item.

[Other]

Regarding the reliability test, as there is no change of wafer, we are scheduled to conduct only the soldering resistance test of the blow surface mount type items.

Products	Result Schedule
EW410	May, 2019
EW414	May, 2019
EW610B	May, 2019
EZ410	June, 2019
EZ471	June, 2019

End of Notice

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